

## 16-Bit I<sup>2</sup>C™ I/O Expander

### Features

- 16-bit remote bidirectional I/O port
  - 16 I/O pins default to 16 inputs
- Fast I<sup>2</sup>C™ bus clock frequency (0 - 400 kbits/s)
- Three hardware address pins allow use of up to eight devices
- High-current drive capability per I/O:  $\pm 25$  mA
- Open-drain interrupt output on input change
- Interrupt port capture register
- Internal Power-On Reset (POR)
- Polarity inversion register to configure the polarity of the input port data
- Compatible with most microcontrollers
- Available temperature range:
  - Industrial (I): -40°C to +85°C

### CMOS Technology

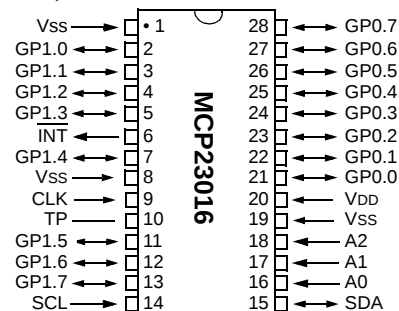
- Operating Supply Voltage: 2.0V to 5.5V
- Low standby current

### Packages

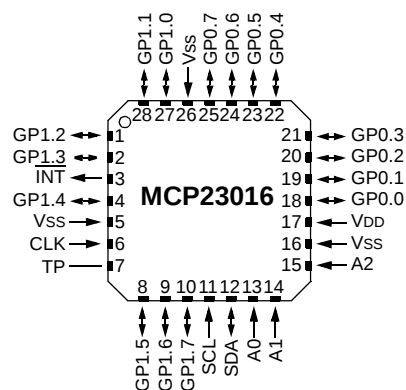
- 28-pin PDIP, 300 mil; 28-pin SOIC, 300 mil
- 28-pin SSOP, 209 mil; 28-pin QFN, 6x6 mm

### Package Types

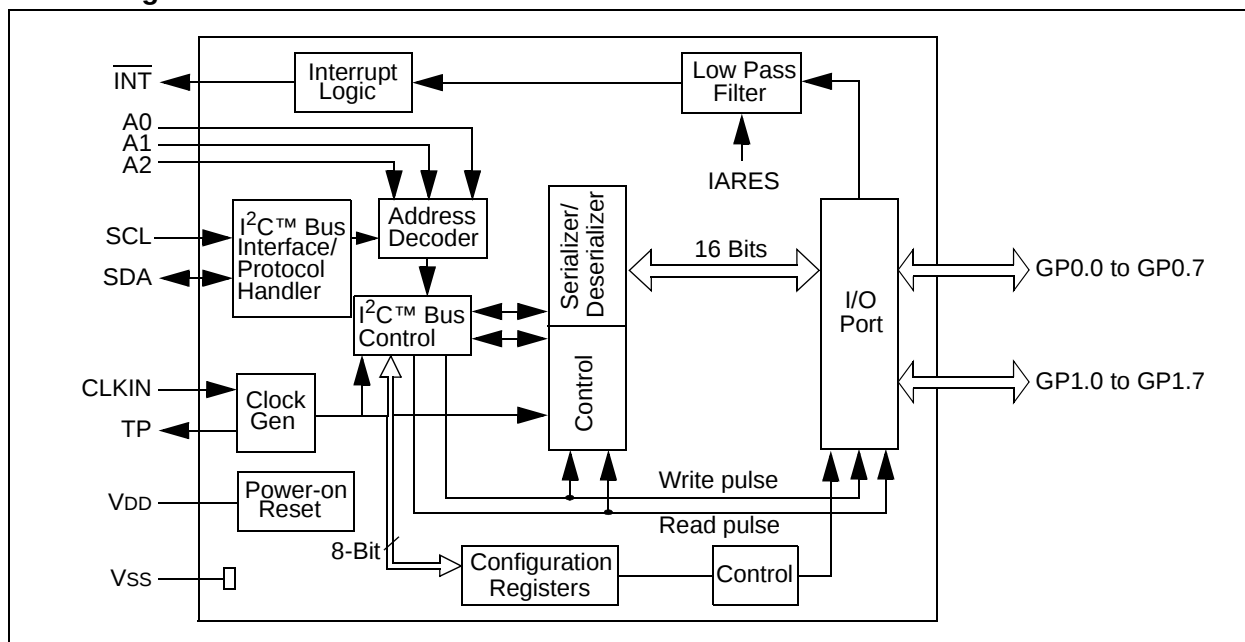
#### PDIP, SOIC, SSOP



#### QFN



### Block Diagram



# MCP23016

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NOTES:

## 1.0 DEVICE OVERVIEW

The MCP23016 device provides 16-bit, general purpose, parallel I/O expansion for I<sup>2</sup>C bus applications.

This device includes high-current drive capability, low supply current and individual I/O configuration. I/O expanders provide a simple solution when additional I/Os are needed for ACPI, power switches, sensors, push buttons, LEDs and so on.

The MCP23016 consists of multiple 8-bit configuration registers for input, output and polarity selection. The system master can enable the I/Os as either inputs or outputs by writing the I/O configuration bits. The data for each input or output is kept in the corresponding

input or output register. The polarity of the read register can be inverted with the polarity inversion register (see **Section 1.7.3, “Input Polarity Registers”**). All registers can be read by the system master.

The open-drain interrupt output is activated when any input state differs from its corresponding input port register state. This is used to indicate to the system master that an input state has changed. The interrupt capture register captures port value at this time. The Power-on Reset sets the registers to their default values and initializes the device state machine.

Three device inputs (A0 - A2) determine the I<sup>2</sup>C address and allow up to eight I/O expander devices to share the same I<sup>2</sup>C bus.

## 1.1 Pin Descriptions

**TABLE 1-1: PINOUT DESCRIPTION**

| Pin Name                | PDIP,<br>SOIC,<br>SSOP<br>Pin No. | QFN<br>Pin No. | I/O/P<br>Type | Buffer<br>Type | Description                               |
|-------------------------|-----------------------------------|----------------|---------------|----------------|-------------------------------------------|
| CLK                     | 9                                 | 6              | I             | ST             | Clock source input                        |
| TP                      | 10                                | 7              | O             | —              | Test Pin (This pin must be left floating) |
| GP1.0                   | 2                                 | 27             | I/O           | TTL            | D0 digital input/output for GP1           |
| GP1.1                   | 3                                 | 28             | I/O           | TTL            | D1 digital input/output for GP1           |
| GP1.2                   | 4                                 | 1              | I/O           | TTL            | D2 digital input/output for GP1           |
| GP1.3                   | 5                                 | 2              | I/O           | TTL            | D3 digital input/output for GP1           |
| GP1.4                   | 7                                 | 4              | I/O           | TTL            | D4 digital input/output for GP1           |
| GP1.5                   | 11                                | 8              | I/O           | ST             | D5 digital input/output for GP1           |
| GP1.6                   | 12                                | 9              | I/O           | ST             | D6 digital input/output for GP1           |
| GP1.7                   | 13                                | 10             | I/O           | ST             | D7 digital input/output for GP1           |
| GP0.0                   | 21                                | 18             | I/O           | TTL            | D0 digital input/output for GP0           |
| GP0.1                   | 22                                | 19             | I/O           | TTL            | D1 digital input/output for GP0           |
| GP0.2                   | 23                                | 20             | I/O           | TTL            | D2 digital input/output for GP0           |
| GP0.3                   | 24                                | 21             | I/O           | TTL            | D3 digital input/output for GP0           |
| GP0.4                   | 25                                | 22             | I/O           | TTL            | D4 digital input/output for GP0           |
| GP0.5                   | 26                                | 23             | I/O           | TTL            | D5 digital input/output for GP0           |
| GP0.6                   | 27                                | 24             | I/O           | TTL            | D6 digital input/output for GP0           |
| GP0.7                   | 28                                | 25             | I/O           | TTL            | D7 digital input/output for GP0           |
| SCL                     | 14                                | 11             | I             | ST             | Serial clock input                        |
| SDA                     | 15                                | 12             | I/O           | ST             | Serial data I/O                           |
| $\overline{\text{INT}}$ | 6                                 | 3              | O             | OD             | Interrupt output                          |
| A0                      | 16                                | 13             | I             | ST             | Address input 1                           |
| A1                      | 17                                | 14             | I             | ST             | Address input 2                           |
| A2                      | 18                                | 15             | I             | ST             | Address input 3                           |
| Vss                     | 1, 8, 19                          | 5, 16, 26      | P             | —              | Ground reference for logic and I/O pins   |
| VDD                     | 20                                | 17             | P             | —              | Positive supply for logic and I/O pins    |

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## 1.2 Power-on Reset (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level to deactivate the POR circuit (i.e., release RESET). A maximum rise time for VDD is specified in the electrical specifications.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature) must be met to ensure proper operation.

## 1.3 Power-up Timer (PWRT)

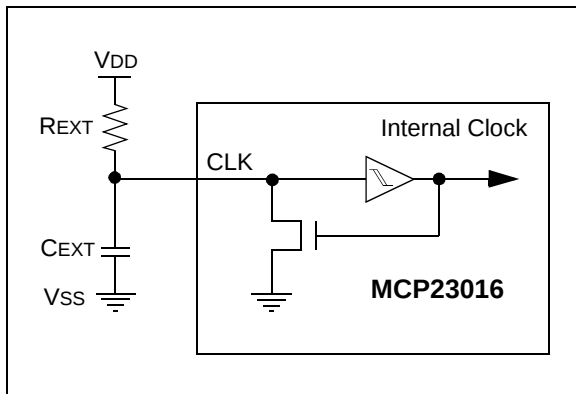
The Power-up Timer provides a 72 ms nominal time-out on power-up, keeping the device in RESET and allowing VDD to rise to an acceptable level.

The power-up time delay will vary from chip-to-chip due to VDD, temperature and process variation. See Table 2-4 for details (TPWRT, parameter 3).

## 1.4 Clock Generator

The MCP23016 uses an external RC circuit to determine the internal clock speed. The user must connect R and C to the MCP23016, as shown in Figure 1-1.

FIGURE 1-1: CLOCK CONFIGURATION



A 1 MHz (typ.) internal clock is needed for the device to function properly. The internal clock can be measured on the TP pin. Recommended REXT and CEXT values are shown in Table 1-2.

**Note:** Set IARES = 1 to measure the clock output on TP.

TABLE 1-2: RECOMMENDED VALUES

| REXT   | CEXT  |
|--------|-------|
| 3.9 kΩ | 33 pF |

## 1.5 I<sup>2</sup>C Bus Interface/ Protocol Handler

This block manages the functionality of the I<sup>2</sup>C bus interface and protocol handling. The MCP23016 supports the following commands:

TABLE 1-3: COMMAND BYTE TO REGISTER RELATIONSHIP

| Command Byte | Result                        |
|--------------|-------------------------------|
| 0h           | Access to GP0                 |
| 1h           | Access to GP1                 |
| 2h           | Access to OLAT0               |
| 3h           | Access to OLAT1               |
| 4h           | Access to IPOL0               |
| 5h           | Access to IPOL1               |
| 6h           | Access to IODIR0              |
| 7h           | Access to IODIR1              |
| 8h           | Access to INTCAP0 (Read-Only) |
| 9h           | Access to INTCAP1 (Read-Only) |
| Ah           | Access to IOCON0              |
| Bh           | Access to IOCON1              |

## 1.6 Address Decoder

The last three LSb of the 7-bit address are user-defined (see Table 1-4). Three hardware pins (<A2:A0>) define these bits.

TABLE 1-4: DEVICE ADDRESS

|   |   |   |   |    |    |    |
|---|---|---|---|----|----|----|
| 0 | 1 | 0 | 0 | A2 | A1 | A0 |
|---|---|---|---|----|----|----|

## 1.7 Register Block

The register block contains the Configuration and Port registers, as shown in Table 1-5.

**TABLE 1-5: REGISTER SUMMARY**

| Name                           | Bit 7  | Bit 6  | Bit 5  | Bit 4  | Bit 3  | Bit 2  | Bit 1  | Bit 0  | Value on POR |
|--------------------------------|--------|--------|--------|--------|--------|--------|--------|--------|--------------|
| <b>Port Registers</b>          |        |        |        |        |        |        |        |        |              |
| GP0                            | GP0.7  | GP0.6  | GP0.5  | GP0.4  | GP0.3  | GP0.2  | GP0.1  | GP0.0  | 0000 0000    |
| GP1                            | GP1.7  | GP1.6  | GP1.5  | GP1.4  | GP1.3  | GP1.2  | GP1.1  | GP0.0  | 0000 0000    |
| OLAT0                          | OL0.7  | OL0.6  | OL0.5  | OL0.4  | OL0.3  | OL0.2  | OL0.1  | OL0.0  | 0000 0000    |
| OLAT1                          | OL1.7  | OL1.6  | OL1.5  | OL1.4  | OL1.3  | OL1.2  | OL1.1  | OL1.0  | 0000 0000    |
| <b>Configuration Registers</b> |        |        |        |        |        |        |        |        |              |
| IPOL0                          | IGP0.7 | IGP0.6 | IGP0.5 | IGP0.4 | IGP0.3 | IGP0.2 | IGP0.1 | IGP0.0 | 0000 0000    |
| IPOL1                          | IGP1.7 | IGP1.6 | IGP1.5 | IGP1.4 | IGP1.3 | IGP1.2 | IGP1.1 | IGP1.0 | 0000 0000    |
| IODIR0                         | IOD0.7 | IOD0.6 | IOD0.5 | IOD0.4 | IOD0.3 | IOD0.2 | IOD0.1 | IOD0.0 | 1111 1111    |
| IODIR1                         | IOD1.7 | IOD1.6 | IOD1.5 | IOD1.4 | IOD1.3 | IOD1.2 | IOD1.1 | IOD1.0 | 1111 1111    |
| INTCAP0                        | ICP0.7 | ICP0.6 | ICP0.5 | ICP0.4 | ICP0.3 | ICP0.2 | ICP0.1 | ICP0.0 | xxxx xxxx    |
| INTCAP1                        | ICP1.7 | ICP1.6 | ICP1.5 | ICP1.4 | ICP1.3 | ICP1.2 | ICP1.1 | ICP1.0 | xxxx xxxx    |
| IOCON0                         | —      | —      | —      | —      | —      | —      | —      | IARES  | ---- ---0    |
| IOCON1                         | —      | —      | —      | —      | —      | —      | —      | IARES  | ---- ---0    |

**Legend:** '1' bit is set, '0' bit is cleared, x = unknown, — = unimplemented.

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## 1.7.1 DATA PORT REGISTERS

Two registers provide access to the two GPIO ports:

- GP0 (provides access to data port GP0)
- GP1 (provides access to data port GP1)

A read from this register provides status on pins of these ports. A write to these registers will modify the output latch registers (OLAT0, OLAT1) and data output.

### REGISTER 1-1: GP0 - GENERAL PURPOSE I/O PORT REGISTER 0

|       |       |       |       |       |       |       |       |
|-------|-------|-------|-------|-------|-------|-------|-------|
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
| GP0.7 | GP0.6 | GP0.5 | GP0.4 | GP0.3 | GP0.2 | GP0.1 | GP0.0 |
| bit 7 |       |       |       | bit 0 |       |       |       |

bit 7-0 **GP0.0:GP0.7:** Reflects the logic level on the pins.  
1 = Logic '1'  
0 = Logic '0'

#### Legend:

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

### REGISTER 1-2: GP1 - GENERAL PURPOSE I/O PORT REGISTER 1

|       |       |       |       |       |       |       |       |
|-------|-------|-------|-------|-------|-------|-------|-------|
| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
| GP1.7 | GP1.6 | GP1.5 | GP1.4 | GP1.3 | GP1.2 | GP1.1 | GP1.0 |
| bit 7 |       |       |       | bit 0 |       |       |       |

bit 7-0 **GP1.0:GP1.7:** Reflects the logic level on the pins.  
1 = Logic '1'  
0 = Logic '0'

#### Legend:

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

## 1.7.2 OUTPUT LATCH REGISTERS

Two registers provide access to the two port output latches:

- OLAT0 (provides access to the output latch for port GP0)
- OLAT1 (provides access to the output latch for port GP1)

A read from these registers results in a read of the latch that controls the output and not the actual port. A write to these registers updates the output latch that controls the output.

### REGISTER 1-3: OLAT0 - OUTPUT LATCH REGISTER 0

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| OL0.7 | OL0.6 | OL0.5 | OL0.4 | OL0.3 | OL0.2 | OL0.1 | OL0.0 |
| bit 7 |       |       |       | bit 0 |       |       |       |

bit 7-0 **OL0.0:OL0.7:** Reflects the logic level on the output latch.  
 1 = Logic '1'  
 0 = Logic '0'

#### Legend:

R = Readable bit      W = Writable bit      U = Unimplemented bit, read as '0'  
 - n = Value at POR      '1' = Bit is set      '0' = Bit is cleared      x = Bit is unknown

### REGISTER 1-4: OLAT1 - OUTPUT LATCH REGISTER 1

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 |
|-------|-------|-------|-------|-------|-------|-------|-------|
| OL1.7 | OL1.6 | OL1.5 | OL1.4 | OL1.3 | OL1.2 | OL1.1 | OL1.0 |
| bit 7 |       |       |       | bit 0 |       |       |       |

bit 7-0 **OL1.0:OL1.7:** Reflects the logic level on the output latch.  
 1 = Logic '1'  
 0 = Logic '0'

#### Legend:

R = Readable bit      W = Writable bit      U = Unimplemented bit, read as '0'  
 - n = Value at POR      '1' = Bit is set      '0' = Bit is cleared      x = Bit is unknown

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## 1.7.3 INPUT POLARITY REGISTERS

These registers allow the user to configure the polarity of the input port data (GP0 and GP1). If a bit in this register is set, the corresponding input port (GPn) data bit polarity will be inverted.

- IPOL0 (controls the polarity of GP0)
- IPOL1 (controls the polarity of GP1)

### REGISTER 1-5: IPOL0 - INPUT POLARITY PORT REGISTER 0

| R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| IGP0.7 | IGP0.6 | IGP0.5 | IGP0.4 | IGP0.3 | IGP0.2 | IGP0.1 | IGP0.0 |
| bit 7  |        |        |        | bit 0  |        |        |        |

bit 7-0 **IGP0.0:IGP0.7:** Controls the polarity inversion for the input pins  
1 = Corresponding GP0 bit is inverted  
0 = Corresponding GP0 bit is not inverted

**Legend:**

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

### REGISTER 1-6: IPOL1 - INPUT POLARITY PORT REGISTER 1

| R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  | R/W-0  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| IGP1.7 | IGP1.6 | IGP1.6 | IGP1.4 | IGP1.3 | IGP1.2 | IGP1.1 | IGP1.0 |
| bit 7  |        |        |        | bit 0  |        |        |        |

bit 7-0 **IGP1.0:IGP1.7:** Controls the polarity inversion for the input pins  
1 = Corresponding GP1 bit is inverted  
0 = Corresponding GP1 bit is not inverted

**Legend:**

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

## 1.7.4 I/O DIRECTION REGISTERS

Two registers control the direction of data I/O:

- IODIR0 (controls GP0)
- IODIR1 (controls GP1)

When a bit in these registers is set, the corresponding pin becomes an input. Otherwise, it becomes an output. At Power-on Reset, the device ports are configured as inputs.

**REGISTER 1-7: IODIR0 - I/O DIRECTION REGISTER 0**

| R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| IOD0.7 | IOD0.6 | IOD0.5 | IOD0.4 | IOD0.3 | IOD0.2 | IOD0.1 | IOD0.0 |
| bit 7  |        |        |        | bit 0  |        |        |        |

bit 7-0 **IOD0.0:IOD0.7:** Controls the direction of data I/O

1 = Input  
0 = Output

**Legend:**

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

**REGISTER 1-8: IODIR1 - I/O DIRECTION REGISTER 1**

| R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  | R/W-1  |
|--------|--------|--------|--------|--------|--------|--------|--------|
| IOD1.7 | IOD1.6 | IOD1.5 | IOD1.4 | IOD1.3 | IOD1.2 | IOD1.1 | IOD1.0 |
| bit 7  |        |        |        | bit 0  |        |        |        |

bit 7-0 **IOD1.0:IOD1.7:** Controls the direction of data I/O

1 = Input  
0 = Output

**Legend:**

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

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## 1.7.5 INTERRUPT CAPTURE REGISTERS

Two registers contain the value of the port that generated the interrupt:

- INTCAP0 contains the value of GP0 at time of GP0 change interrupt
- INTCAP1 contains the value of GP1 at time of GP1 change interrupt

These registers are 'read-only' registers (A write to these registers is ignored).

### REGISTER 1-9: INTCAP0 - INTERRUPT CAPTURED VALUE FOR PORT REGISTER 0

|        |        |        |        |        |        |        |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| R-x    | R-x    | R-x    | R-x    | R-x    | R-x    | R-x    | R-x    |
| ICP0.7 | ICP0.6 | ICP0.5 | ICP0.4 | ICP0.3 | ICP0.2 | ICP0.1 | ICP0.0 |
| bit 7  |        |        |        | bit 0  |        |        |        |

bit 7-0 **ICP0.0:ICP0.7:** Reflects the logic level on the GP0 pins at the time of interrupt due to pin change  
1 = Logic '1'  
0 = Logic '0'

#### Legend:

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

### REGISTER 1-10: INTCAP1 - INTERRUPT CAPTURED VALUE FOR PORT REGISTER 1

|        |        |        |        |        |        |        |        |
|--------|--------|--------|--------|--------|--------|--------|--------|
| R-x    | R-x    | R-x    | R-x    | R-x    | R-x    | R-x    | R-x    |
| ICP1.7 | ICP1.6 | ICP1.5 | ICP1.4 | ICP1.3 | ICP1.2 | ICP1.1 | ICP1.0 |
| bit 7  |        |        |        | bit 0  |        |        |        |

bit 7-0 **ICP1.0:ICP1.7:** Reflects the logic level on the GP1 pins at the time of interrupt due to pin change  
1 = Logic '1'  
0 = Logic '0'

#### Legend:

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

## 1.7.6 I/O EXPANDER CONTROL REGISTER

- IOCON0 controls the functionality of the MCP23016.

The IARES (Interrupt Activity Resolution) bit controls the sampling frequency of the GP port pins. The higher the sampling frequency, the higher the device current requirements. If this bit is '0' (default), the maximum time to detect the activity on the port is 32 ms (max.), which results in lower standby current. If this bit is '1', the maximum time to detect activity on the port is 200  $\mu$ sec. (max.) and results in higher standby current.

### REGISTER 1-11: IOCON0 - I/O EXPANDER CONTROL REGISTER

|       |     |     |     |     |     |     |       |
|-------|-----|-----|-----|-----|-----|-----|-------|
| U-0   | U-0 | U-0 | U-0 | U-0 | U-0 | U-0 | R/W-0 |
| —     | —   | —   | —   | —   | —   | —   | IARES |
| bit 7 |     |     |     |     |     |     | bit 0 |

bit 1-7 **Unimplemented bit:** Read as '0'

bit 0 **IARES:** Interrupt Activity Resolution  
 1 = Fast sample rate  
 0 = Normal sample rate

#### Legend:

|                    |                  |                                            |
|--------------------|------------------|--------------------------------------------|
| R = Readable bit   | W = Writable bit | U = Unimplemented bit, read as '0'         |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared    x = Bit is unknown |

**IOCON1** is a shadow register for IOCON0. Access to IOCON1 results in access to IOCON0.

## 1.8 Serializer/Deserializer

The Serializer/Deserializer block converts and transfers data between the I<sup>2</sup>C bus and GPIO.

## 1.9 Interrupt Logic

The MCP23016 asserts the open-drain interrupt output (INT) low when one of the port pins changes state. Only those pins that are configured as an input can cause an interrupt. Pins defined as an output have no effect on INT. The interrupt will remain active until a read from either the port (GPn) on which the interrupt occurred or the INTCAPn register is performed. If the input returns to its previous state before a read operation, it will reset the interrupt and the INT pin output will tri-state. Each 8-bit port is read separately, so reading GP0 or INTCAP0 will not clear the interrupt generated by GP1 or INTCAP1, and vice versa.

Input change activity on each port will generate an interrupt and the value of the particular port will be captured and copied into INTCAP0/INTCAP1. The INTCAPn registers are only updated when an interrupt occurs on INT. These values will stay unchanged until the user clears the interrupt by reading the port or the INTCAPn register.

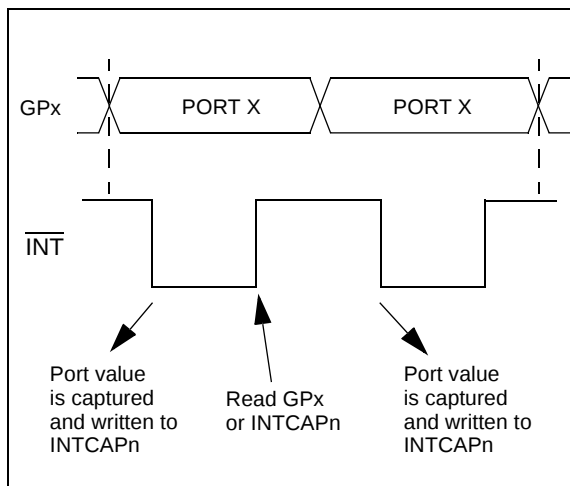
If the input port value changes back to normal before a user-read, the  $\overline{\text{INT}}$  output will be reset. However, the INTCAP0/INTCAP1 will still contain the value of the port at the interrupt change. If the port value changes again, it will re-activate the interrupt and the new value will be captured.

The first interrupt on change event following an interrupt RESET will result in a capture event. Any further change event that occurs before the interrupt is reset will not result in a capture event.

### 1.9.1 INTERRUPT EVENT DETECTION

The IARES bit controls the resolution for detecting an interrupt-on-change event. If this bit is '0' (default), the maximum time for detecting a change of event is high, which results in lower standby current. If this bit is '1', it takes less time for scanning the activity on the port and results in higher standby current.

**FIGURE 1-2: READING PORTX AFTER INTERRUPT EVENT**



## 1.9.2 WRITING THE REGISTERS

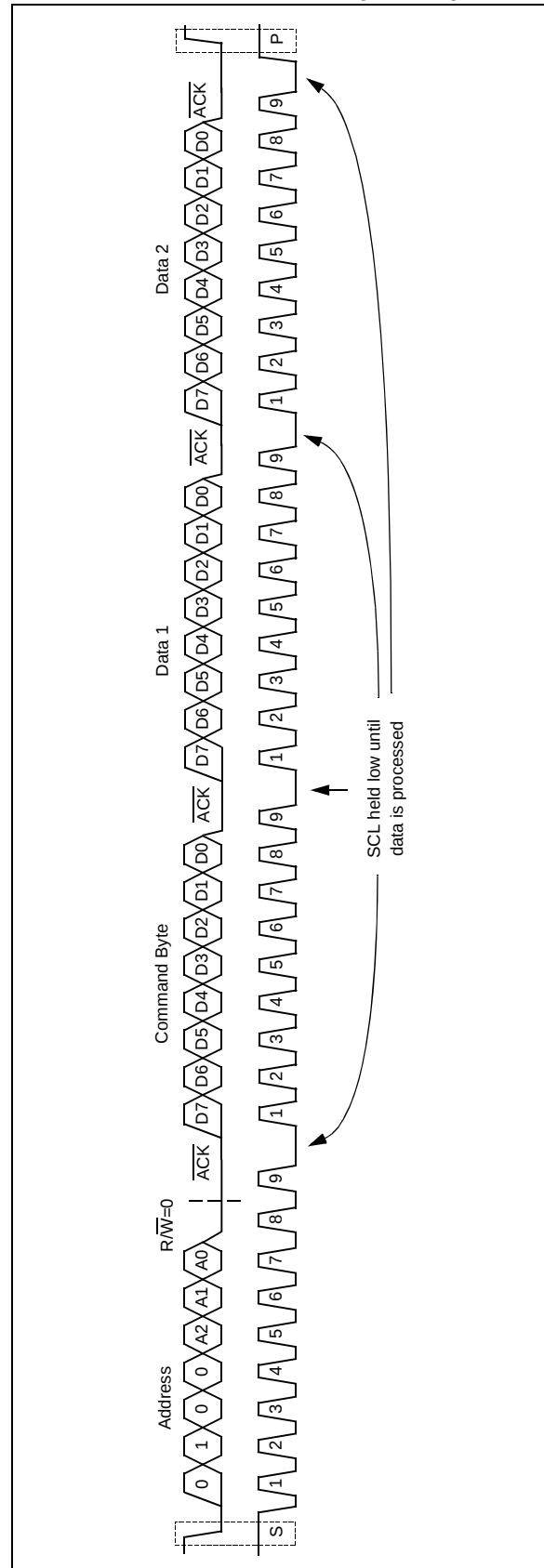
To write to a MCP23016 register, the Master I<sup>2</sup>C device needs to follow the requirements, as illustrated in Figure 1-3. First, the device is selected by sending the slave address and setting the R/W bit to logic '0'. The command byte is sent after the address and determines which register will be written. Table 1-3 shows the relationship of the command byte and register.

The MCP23016 has twelve 8-bit registers. They are configured to operate as six 16-bit register pairs, supporting the device's 16-bit port. These pairs are formed based on their functions (e.g., GP0 and GP1 are grouped together). The I<sup>2</sup>C commands apply to one register pair to provide faster access. The first data byte following a command byte is written into the register pointed to by the command byte, while the second data is written into another register in the same pair. For example, if the first byte is sent to OLAT1 (command byte 03h), the next data byte will be written into the second register of that pair, OLAT0. If the first byte is written to OLAT0 (command byte 02h), the second byte will be written to OLAT1.

There is no limitation on the number of data bytes in one write transmission. Figure 1-4 shows the case of multiple byte writes in one write operation. In this case, the multiple writes are made to the same data pair.

**Note:** The bus must remain free until after the ninth clock pulse for a minimum of 12  $\mu$ s (see Table 2-5 and Figure 2-4).

**FIGURE 1-3: WRITE TO CONFIGURATION REGISTERS (CASE 1)**



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The diagram illustrates the timing of a read operation with 10-bit data. The sequence of events is as follows:

- Address:** 0, 1, 0, 0 (labeled with A0, A1, A2, A3).
- Command Byte:** D7, D6, D5, D4, D3, D2, D1, D0 (labeled with ACK).
- Data 1:** D7, D6, D5, D4, D3, D2, D1, D0 (labeled with ACK).
- Data 2:** D7, D6, D5, D4, D3, D2, D1, D0 (labeled with ACK).
- ACK:** 1, 2, 3, 4, 5, 6, 7, 8, 9 (labeled with S).

The diagram shows the period where the SCL line is held low until data is processed, and the period where the SCL line is held low until data is processed after the ACK.

The diagram illustrates the timing of an I2C read operation. The SDA line shows the sequence of data bytes: Address (0, 1, 0, 0), Command Byte (A0, A1, D0-D7), Data 1 (D0-D7), and Data 2 (D0-D7). The SCL line shows the clock pulses, with a period where it is held low until data is processed. The GP pins (Data on GP0 and Data on GP1) show the data being read from the device. The timing parameters  $t_{GPV0}$  and  $t_{GPV1}$  are indicated, representing the time from the start of the data valid period to the start of the data period.

## 1.9.3 READING THE REGISTERS

To read a MCP23016 register, the Master needs to follow the requirements shown in Figure 1-6. First, the device is selected by sending the slave address and setting the R/W bit to logic '0'. The command byte is sent after the address and determines which register will be read. A restart condition is generated and the device address is sent again with the R/W bit set to logic '1'. The data register defined by the command byte will be sent first, followed by the other register in the register pair. The logic for register selection is the same as explained in Write mode (**Section 1.9.2, "Writing the Registers"**).

The falling edge of the ninth clock initiates the register read action. The SCL clock will be held low while the data is read from the register and is transferred to the I<sup>2</sup>C bus control block by the Serializer/Deserializer block.

The MCP23016 holds the clock low after the falling edge of the ninth clock pulse. The configuration registers (or port control registers) are read and the value is stored. Finally, the clock is released to enable the next transmission.

There is no limitation on the number of data bytes in one read transmission. Figure 1-8 shows the case of multiple byte read in one read operation. In this case, the multiple writes are made to the same data pair.

**Note:** The bus must remain free until after the ninth clock pulse for a minimum of 12  $\mu$ s (see Table 2-5 and Figure 2-4).

**FIGURE 1-6: READ FROM CONFIGURATION REGISTER**

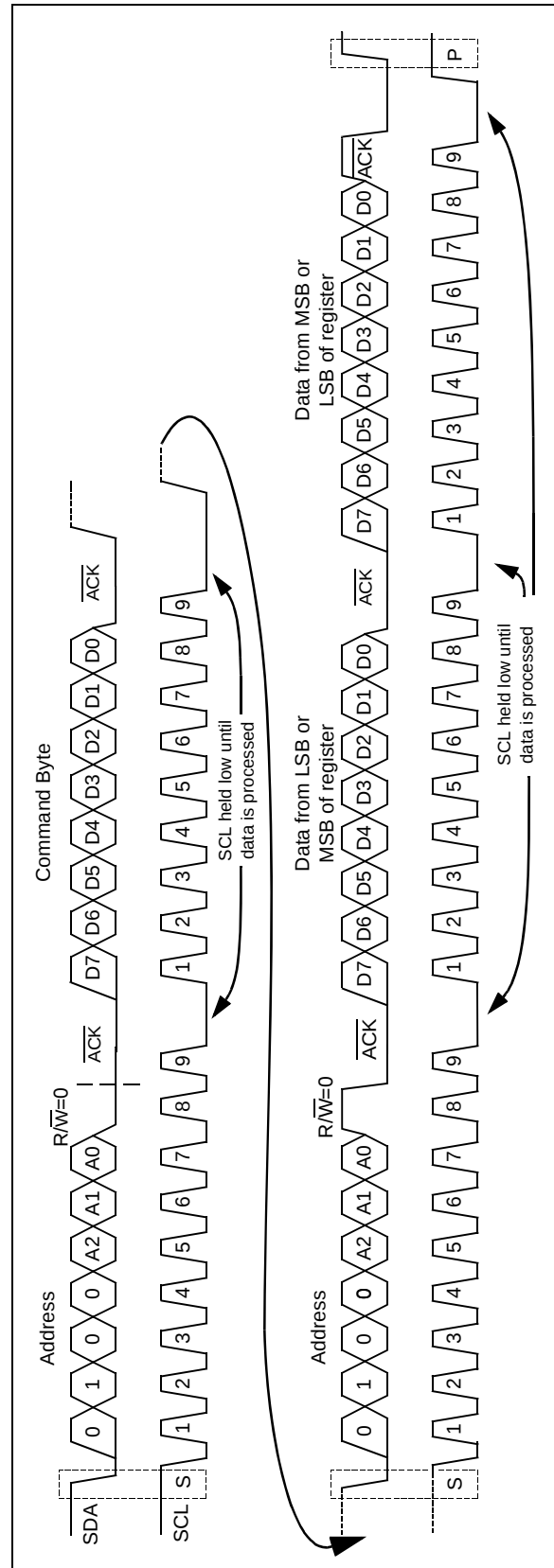
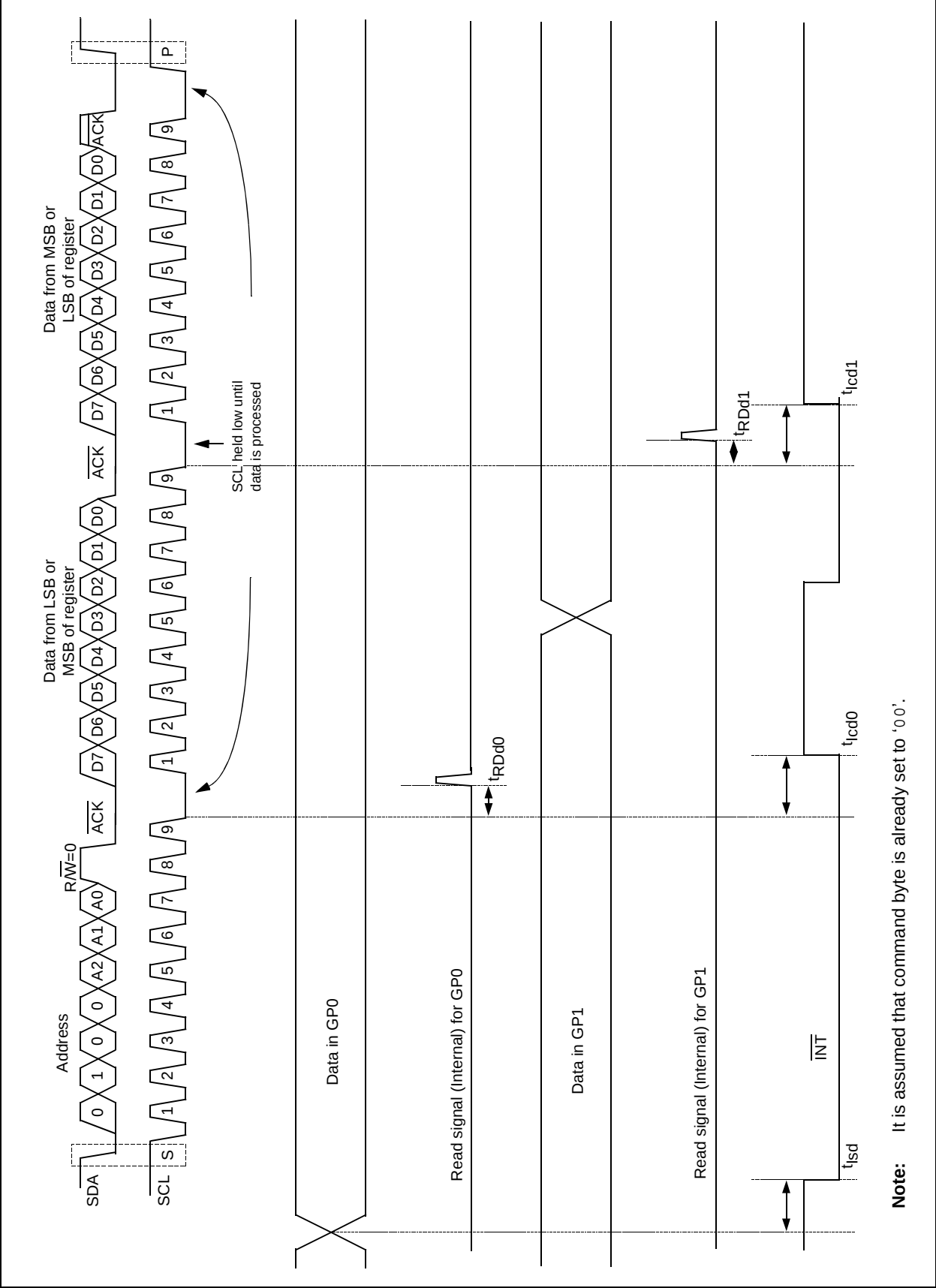
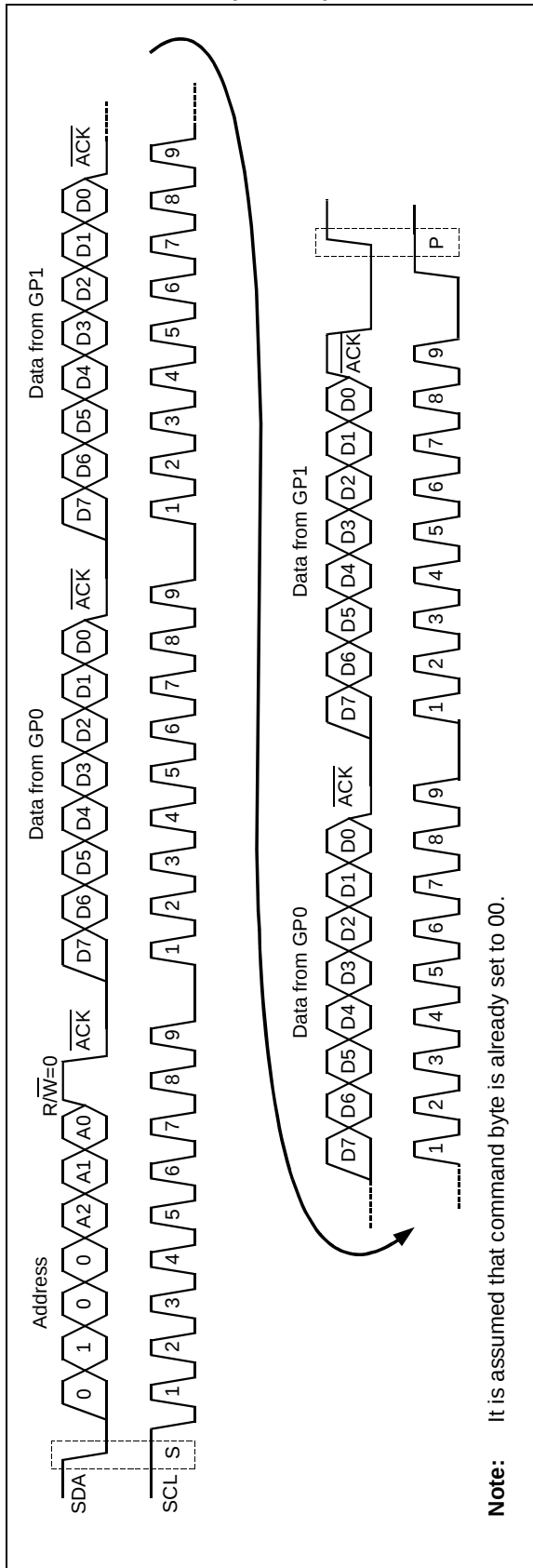


FIGURE 1-7: READ FROM INPUT PORTS (CASE 1)



**FIGURE 1-8: READ FROM INPUT PORTS (CASE 2)**



# MCP23016

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NOTES:

## 2.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings †

|                                                                                                        |                                   |
|--------------------------------------------------------------------------------------------------------|-----------------------------------|
| Ambient temperature under bias .....                                                                   | -55 to +125°C                     |
| Storage temperature .....                                                                              | -65°C to +150°C                   |
| Voltage on any pin with respect to VSS .....                                                           | -0.3V to (V <sub>DD</sub> + 0.3V) |
| Voltage on V <sub>DD</sub> with respect to VSS .....                                                   | -0.3V to +6.5V                    |
| Total power dissipation ( <b>Note 1</b> ) .....                                                        | 1.0 W                             |
| Maximum current out of VSS pin .....                                                                   | 300 mA                            |
| Maximum current into V <sub>DD</sub> pin .....                                                         | 250 mA                            |
| Input clamp current, I <sub>IK</sub> (V <sub>I</sub> < 0, or V <sub>I</sub> > V <sub>DD</sub> ) .....  | ± 20 mA                           |
| Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0, or V <sub>O</sub> > V <sub>DD</sub> ) ..... | ± 20 mA                           |
| Maximum output current sunk by any I/O pin.....                                                        | 25 mA                             |
| Maximum output current sourced by any I/O pin .....                                                    | 25 mA                             |
| Maximum current sunk by combined PORTS .....                                                           | 200 mA                            |
| Maximum current sourced by combined PORTS .....                                                        | 200 mA                            |

**Note 1:** Power dissipation is calculated as follows:

$$P_{dis} = V_{DD} \times \{I_{DD} - \sum I_{OH}\} + \sum \{(V_{DD} - V_{OH}) \times I_{OH}\} + \sum (V_{OL} \times I_{OL})$$

† **NOTICE:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

# MCP23016

## 2.1 DC Characteristics

TABLE 2-1: DC CHARACTERISTICS

| DC CHARACTERISTICS           |                                                                           |                   | Standard Operating Conditions (unless otherwise stated)<br>Operating temperature: $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial |                 |                      |       |                                                                               |
|------------------------------|---------------------------------------------------------------------------|-------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------|----------------------|-------|-------------------------------------------------------------------------------|
| Param No.                    | Characteristic                                                            | Sym               | Min                                                                                                                                                      | Typ†            | Max                  | Units | Conditions                                                                    |
| D001                         | Supply Voltage                                                            | V <sub>DD</sub>   | 2.0                                                                                                                                                      | —               | 5.5                  | V     |                                                                               |
| D002                         | Standby Current                                                           | I <sub>DD</sub>   | —                                                                                                                                                        | 0.4             |                      | mA    | I <sub>ARES</sub> = 1                                                         |
| D003                         | Standby Current                                                           | I <sub>PD</sub>   | —                                                                                                                                                        | 25              |                      | μA    | I <sub>ARES</sub> = 0                                                         |
| <b>Input Low Voltage</b>     |                                                                           |                   |                                                                                                                                                          |                 |                      |       |                                                                               |
| D004                         | I/O ports                                                                 | V <sub>IL</sub>   | V <sub>SS</sub>                                                                                                                                          | —               | 0.15 V <sub>DD</sub> | V     | For entire V <sub>DD</sub> range<br>4.5V ≤ V <sub>DD</sub> ≤ 5.5V             |
| D004A                        | TTL buffer                                                                |                   | V <sub>SS</sub>                                                                                                                                          | —               | 0.8V                 |       |                                                                               |
| D005                         | Schmitt Trigger buffer                                                    |                   | V <sub>SS</sub>                                                                                                                                          | —               | 0.2 V <sub>DD</sub>  | V     |                                                                               |
|                              | Input High Voltage                                                        |                   |                                                                                                                                                          |                 |                      |       |                                                                               |
| D006                         | I/O ports                                                                 | V <sub>IH</sub>   | 2.0                                                                                                                                                      | —               | V <sub>DD</sub>      | V     | 4.5V ≤ V <sub>DD</sub> ≤ 5.5V                                                 |
| D006A                        | TTL buffer                                                                |                   | 0.25 V <sub>DD</sub><br>+ 0.8V                                                                                                                           | —               | V <sub>DD</sub>      | V     | For entire V <sub>DD</sub> range                                              |
| D007                         | Schmitt Trigger buffer                                                    |                   | 0.8 V <sub>DD</sub>                                                                                                                                      | —               | V <sub>DD</sub>      | V     | For entire V <sub>DD</sub> range                                              |
| <b>Input Leakage Current</b> |                                                                           |                   |                                                                                                                                                          |                 |                      |       |                                                                               |
| D008                         | I/O ports                                                                 | I <sub>IL</sub>   | —                                                                                                                                                        | —               | ±1.0                 | μA    | V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> ,<br>Pin at hi-impedance |
| D009                         | CLK                                                                       |                   | —                                                                                                                                                        | —               | ±5.0                 | μA    | V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub>                          |
| <b>Output Low Voltage</b>    |                                                                           |                   |                                                                                                                                                          |                 |                      |       |                                                                               |
| D010                         | I/O Ports                                                                 | V <sub>OL</sub>   | —                                                                                                                                                        | —               | 0.6                  | V     | I <sub>OL</sub> = 8.5 mA, V <sub>DD</sub> = 4.5V                              |
| <b>Output High Voltage</b>   |                                                                           |                   |                                                                                                                                                          |                 |                      |       |                                                                               |
| D010                         | I/O Ports                                                                 | V <sub>OH</sub>   | V <sub>DD</sub> -0.7                                                                                                                                     | —               | —                    | V     | I <sub>OH</sub> = 3.0 mA, V <sub>DD</sub> = 4.5V                              |
| D011                         | V <sub>DD</sub> start voltage to ensure internal POR signal               | V <sub>POR</sub>  | —                                                                                                                                                        | V <sub>SS</sub> | —                    | V     |                                                                               |
| D012                         | V <sub>DD</sub> rise rate to ensure internal POR signal                   | SV <sub>DD</sub>  | 0.05                                                                                                                                                     | -               | —                    | V/ms  | <b>Note 1</b>                                                                 |
|                              | DC Trip Point                                                             | V <sub>TPOR</sub> | 1.5                                                                                                                                                      | 1.7             | 1.9                  | V     | DC Slow Ramp                                                                  |
| D012                         | V <sub>DD</sub> rise rate to ensure internal POR signal with PWRT enabled | SV <sub>DD</sub>  | 0.05                                                                                                                                                     | —               | —                    | V/ms  | <b>Note 1</b>                                                                 |
|                              | DC Current Draw                                                           | I <sub>POR</sub>  | —                                                                                                                                                        | 5.0             | —                    | μA    | At 5.0V (1 μA/Volt typical)                                                   |

**Note 1:** These parameters are characterized but not tested.

**2:** Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

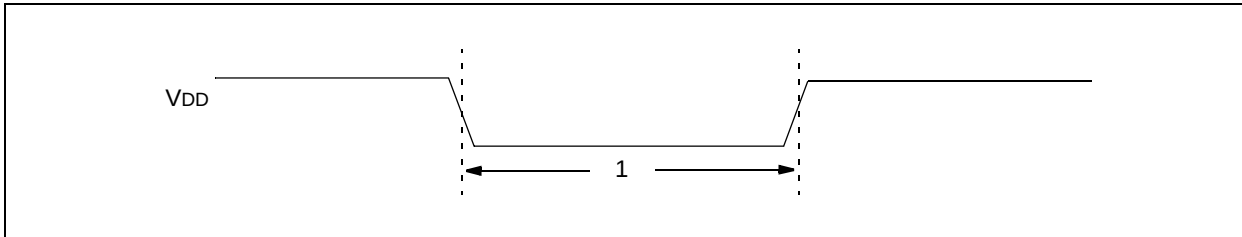
**3:** Standby current is measured with all I/O in hi-impedance state and tied to V<sub>DD</sub> and V<sub>SS</sub>.

**4:** For RC CLK, current through R<sub>EXT</sub> is not included. The current through the resistor can be estimated by the formula

$$I_r = V_{DD}/2 R_{EXT} \text{ (mA) with } R_{EXT} \text{ in kohm.}$$

**5:** Negative current is defined as coming out of the pin.

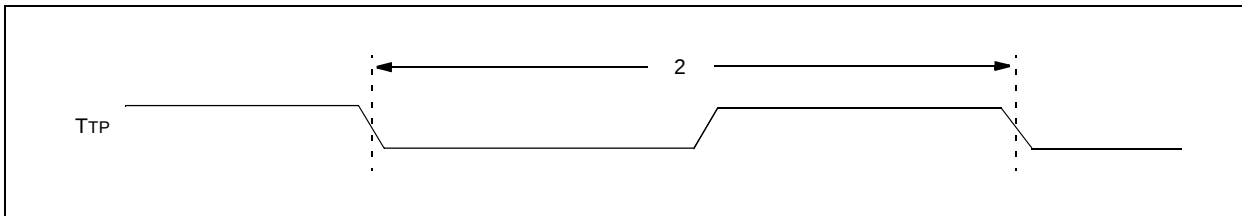
**FIGURE 2-1: RESPONSE TIME**



**TABLE 2-2: RESPONSE TIME**

| Parameter No. | Symbol | Characteristic | Min | Typ† | Max | Units | Conditions                                                                                                                     |
|---------------|--------|----------------|-----|------|-----|-------|--------------------------------------------------------------------------------------------------------------------------------|
| 1             |        | Response Time  | 100 | —    | —   | ns    | Minimum time where a VDD transition from 5.0V to 0.0V to 5.0V will cause a RESET. All times less than 100 ns will be filtered. |

**FIGURE 2-2: TEST POINT CLOCK TIMING**



**TABLE 2-3: TEST POINT CLOCK TIMING**

| Parameter No. | Symbol | Characteristic    | Min | Typ† | Max | Units | Conditions                       |
|---------------|--------|-------------------|-----|------|-----|-------|----------------------------------|
|               | FTP    | TP pin Frequency  | —   | 1.0  | —   | MHz   | Measured at TP pin, IARES = '1'. |
| 2             | TTP    | TP pin CLK Period | —   | 1.0  | —   | μs    | Measured at TP pin, IARES = '1'. |

† Data in "Typ" column is at 5V, +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**TABLE 2-4: POWER-UP TIMER REQUIREMENTS**

| Parameter No. | Symbol | Characteristic        | Min | Typ† | Max | Units | Conditions |
|---------------|--------|-----------------------|-----|------|-----|-------|------------|
| 3             | TPWRT  | Power-up Timer Period | —   | 72   | —   | ms    |            |

† Data in "Typ" column is at 5V, +25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

# MCP23016

FIGURE 2-3: I<sup>2</sup>C BUS START/STOP BITS TIMING

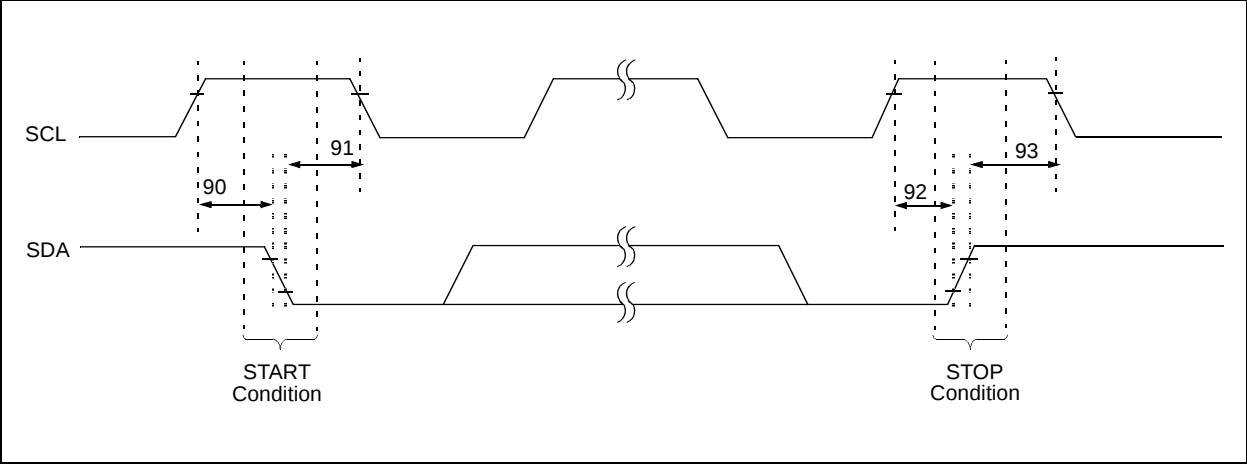
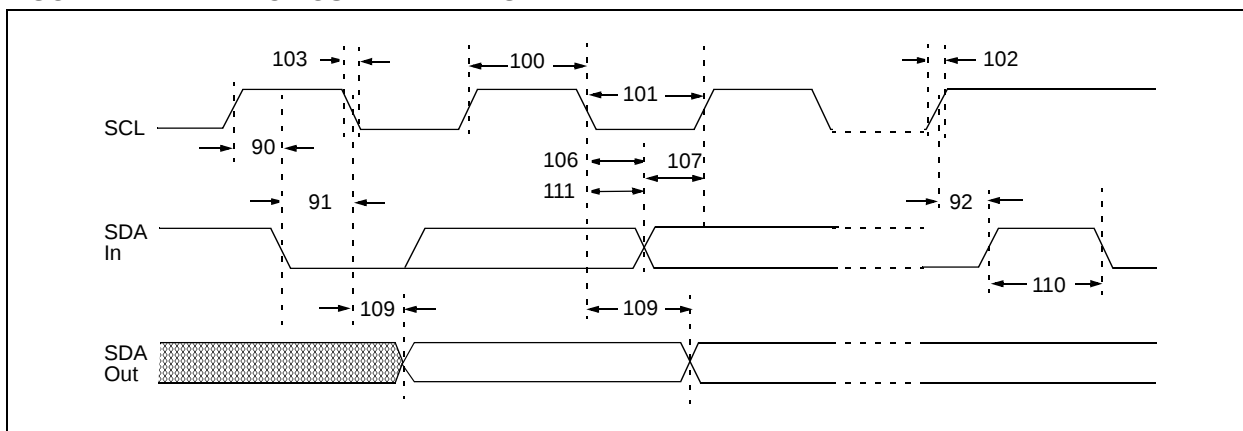


TABLE 2-5: I<sup>2</sup>C BUS START/STOP BITS REQUIREMENTS

| Param No. | Symbol  | Characteristic             |              | Min  | Typ | Max | Units | Conditions                                                              |
|-----------|---------|----------------------------|--------------|------|-----|-----|-------|-------------------------------------------------------------------------|
| 90        | TSU:STA | START condition Setup time | 100 kHz mode | 4700 | —   | —   | ns    | Only relevant for Repeated START condition ( <b>Note 1</b> )            |
|           |         |                            | 400 kHz mode | 600  | —   | —   |       |                                                                         |
| 91        | THD:STA | START condition Hold time  | 100 kHz mode | 4000 | —   | —   | ns    | After this period, the first clock pulse is generated ( <b>Note 1</b> ) |
|           |         |                            | 400 kHz mode | 600  | —   | —   |       |                                                                         |
| 92        | TSU:STO | STOP condition Setup time  | 100 kHz mode | 4700 | —   | —   | ns    |                                                                         |
|           |         |                            | 400 kHz mode | 600  | —   | —   |       |                                                                         |
| 93        | THD:STO | STOP condition Hold time   | 100 kHz mode | 4000 | —   | —   | ns    |                                                                         |
|           |         |                            | 400 kHz mode | 600  | —   | —   |       |                                                                         |

**Note 1:** These parameters are characterized but not tested.

**FIGURE 2-4: I<sup>2</sup>C BUS DATA TIMING**



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**TABLE 2-5: I<sup>2</sup>C BUS DATA REQUIREMENTS**

| Param No. | Symbol              | Characteristic                    |              | Min                     | Max  | Units | Conditions                                                                                     |
|-----------|---------------------|-----------------------------------|--------------|-------------------------|------|-------|------------------------------------------------------------------------------------------------|
| 100       | T <sub>HIGH</sub>   | Clock High Time                   | 100 kHz mode | 4.0                     | —    | μs    | (Note 1)                                                                                       |
|           |                     |                                   | 400 kHz mode | 0.6                     | —    | μs    |                                                                                                |
| 101       | T <sub>LOW</sub>    | Clock Low Time                    | 100 kHz mode | 4.7                     | —    | μs    | (Note 1)                                                                                       |
|           |                     |                                   | 400 kHz mode | 1.3                     | —    | μs    |                                                                                                |
| 102       | T <sub>R</sub>      | SDA and SCL Rise Time             | 100 kHz mode | —                       | 1000 | ns    | (Note 1)                                                                                       |
|           |                     |                                   | 400 kHz mode | 20 + 0.1 C <sub>B</sub> | 300  | ns    |                                                                                                |
| 103       | T <sub>F</sub>      | SDA and SCL Fall Time             | 100 kHz mode | —                       | 300  | ns    | (Note 1)                                                                                       |
|           |                     |                                   | 400 kHz mode | 20 + 0.1 C <sub>B</sub> | 300  | ns    |                                                                                                |
| 90        | T <sub>SU:STA</sub> | START Condition Setup Time        | 100 kHz mode | 4.7                     | —    | μs    | Only relevant for repeated START condition (Note 1)                                            |
|           |                     |                                   | 400 kHz mode | 0.6                     | —    | μs    |                                                                                                |
| 91        | T <sub>HD:STA</sub> | START Condition Hold Time         | 100 kHz mode | 4.0                     | —    | μs    | After this period, the first clock pulse is generated (Note 1)                                 |
|           |                     |                                   | 400 kHz mode | 0.6                     | —    | μs    |                                                                                                |
| 106       | T <sub>HD:DAT</sub> | Data Input Hold Time              | 100 kHz mode | 0                       | —    | ns    | (Note 1)                                                                                       |
|           |                     |                                   | 400 kHz mode | 0                       | 0.9  | μs    |                                                                                                |
| 107       | T <sub>SU:DAT</sub> | Data Input Setup Time             | 100 kHz mode | 250                     | —    | ns    | (Note 1) (Note 3)                                                                              |
|           |                     |                                   | 400 kHz mode | 100                     | —    | ns    |                                                                                                |
| 92        | T <sub>SU:STO</sub> | STOP Condition Setup Time         | 100 kHz mode | 4.7                     | —    | μs    | (Note 1)                                                                                       |
|           |                     |                                   | 400 kHz mode | 0.6                     | —    | μs    |                                                                                                |
| 109       | T <sub>AA</sub>     | Output Valid from Clock           | 100 kHz mode | —                       | 3500 | ns    | (Note 1) (Note 2)                                                                              |
|           |                     |                                   | 400 kHz mode | —                       | —    | ns    |                                                                                                |
| 110       | T <sub>BUF</sub>    | Bus Free Time                     | 100 kHz mode | 4.7                     | —    | μs    | Time the bus must be free before a new transmission can start (Note 1)                         |
|           |                     |                                   | 400 kHz mode | 1.3                     | —    | μs    |                                                                                                |
|           | C <sub>B</sub>      | Bus Capacitive Loading            |              | —                       | 400  | pF    |                                                                                                |
| 111       | T <sub>WAIT</sub>   | Clock wait time after ninth pulse | 100 kHz mode | 12 μs                   | —    | μs    | Time the bus must remain free after the ninth clock pulse before a new transmission can start. |
|           |                     |                                   | 400 kHz mode | 12 μs                   | —    | μs    |                                                                                                |

**Note 1:** These parameters are characterized but not tested.

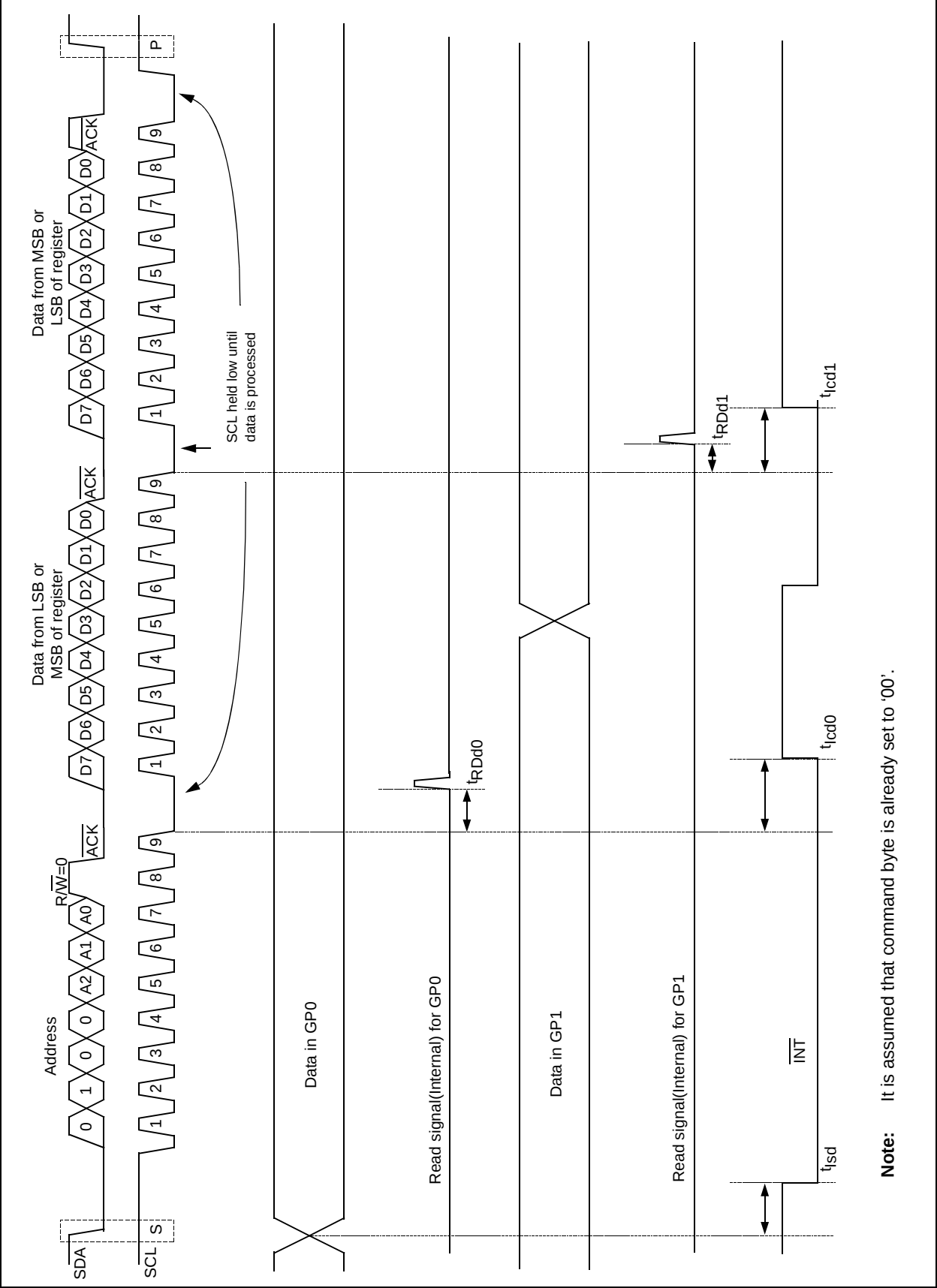
- 2:** As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of START or STOP conditions.
- 3:** A Fast mode (400 kHz) I<sup>2</sup>C bus device can be used in a Standard mode (100 kHz) I<sup>2</sup>C bus system, but the requirement T<sub>SU:DAT</sub> ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the LOW period of the SCL signal. If such a device does stretch the LOW period of the SCL signal, it must output the next data bit to the SDA line T<sub>R</sub> max. + T<sub>SU:DAT</sub> = 1000 + 250 = 1250 ns (according to the Standard mode I<sup>2</sup>C bus specification), before the SCL line is released.

TABLE 2-7: GP0 AND GP1 TIMING REQUIREMENTS

| Param No. | Symbol            | Characteristic                            | Min | Typ. | Max | Units | Conditions            |
|-----------|-------------------|-------------------------------------------|-----|------|-----|-------|-----------------------|
|           | t <sub>GPV0</sub> | GP0 output data valid time                | —   | 40   | —   | μs    | TP = 1 MHz            |
|           | t <sub>GPV1</sub> | GP1 output data valid time                | —   | 50   | —   | μs    |                       |
|           | t <sub>Rd0</sub>  | GP0 data read delay time                  | —   | 40   | —   | μs    |                       |
|           | t <sub>Rd1</sub>  | GP1 data read delay time                  | —   | 50   | —   | μs    |                       |
|           | t <sub>ISD0</sub> | GP0 Interrupt set delay time              | —   | —    | 200 | μs    | IARES = 1, TP = 1 MHz |
|           |                   |                                           | —   | —    | 32  | ms    | IARES = 0, TP = 1 MHz |
|           | t <sub>ISD1</sub> | GP1 Interrupt set delay time              | —   | —    | 200 | μs    | IARES = 1, TP = 1 MHz |
|           |                   |                                           | —   | —    | 32  | ms    | IARES = 0, TP = 1 MHz |
|           | t <sub>LCD0</sub> | GP0 Interrupt clear delay time (for read) | —   | 100  | —   | μs    | TP = 1 MHz            |
|           | t <sub>LCD1</sub> | GP1 Interrupt clear delay time (for read) | —   | 100  | —   | μs    |                       |

**Note 1:** These parameters are characterized but not tested.

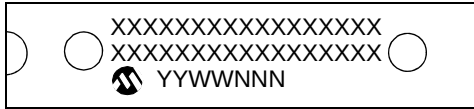
FIGURE 2-5: GP0 AND GP1 PORT TIMINGS



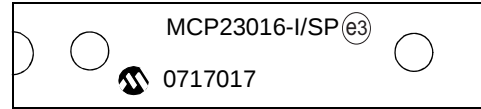
## 3.0 PACKAGE INFORMATION

### 3.1 Package Marking Information

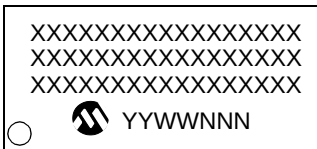
#### 28-Lead PDIP (Skinny DIP)



#### Example:



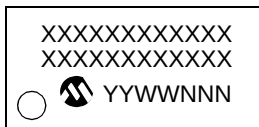
#### 28-Lead SOIC



#### Example:



#### 28-Lead SSOP



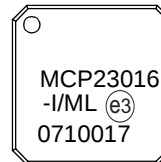
#### Example:



#### 28-Lead QFN



#### Example:



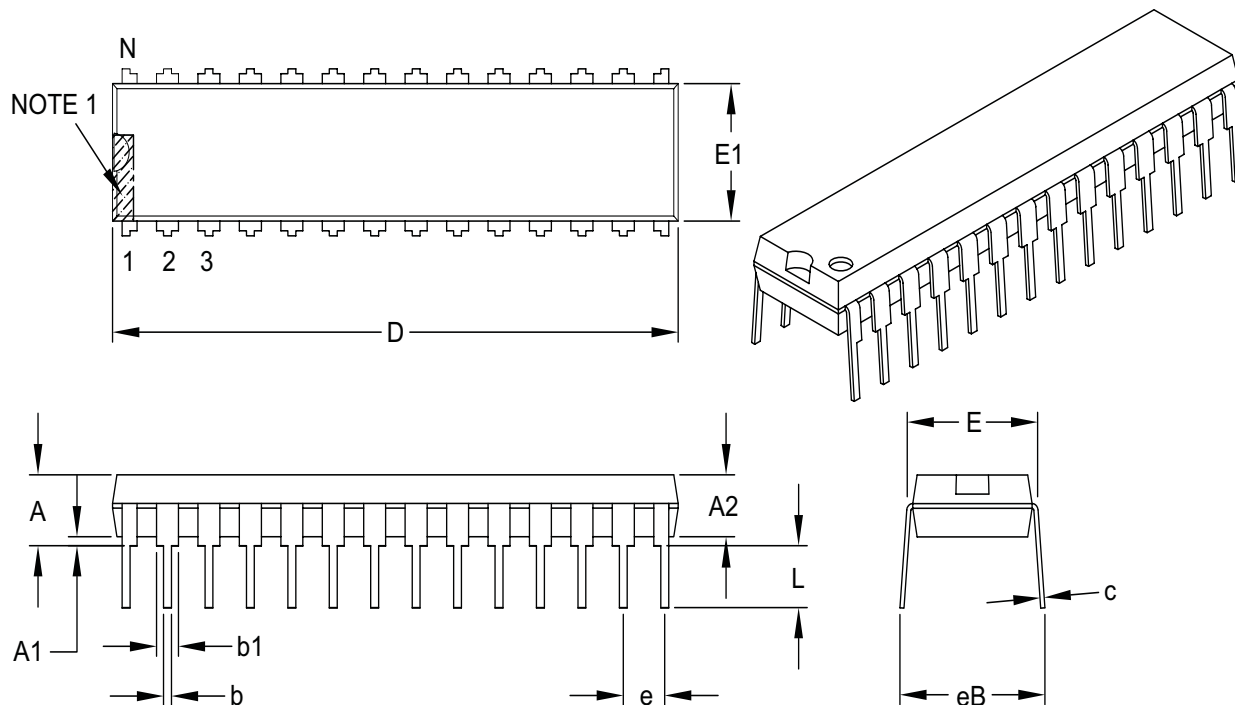
|                |         |                                                                                                                 |
|----------------|---------|-----------------------------------------------------------------------------------------------------------------|
| <b>Legend:</b> | XX...X  | Customer-specific information                                                                                   |
|                | Y       | Year code (last digit of calendar year)                                                                         |
|                | YY      | Year code (last 2 digits of calendar year)                                                                      |
|                | WW      | Week code (week of January 1 is week '01')                                                                      |
|                | NNN     | Alphanumeric traceability code                                                                                  |
|                |         | Pb-free JEDEC designator for Matte Tin (Sn)                                                                     |
|                | *<br>e3 | This package is Pb-free. The Pb-free JEDEC designator ( ) can be found on the outer packaging for this package. |

**Note:** In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.

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## 28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packageing>



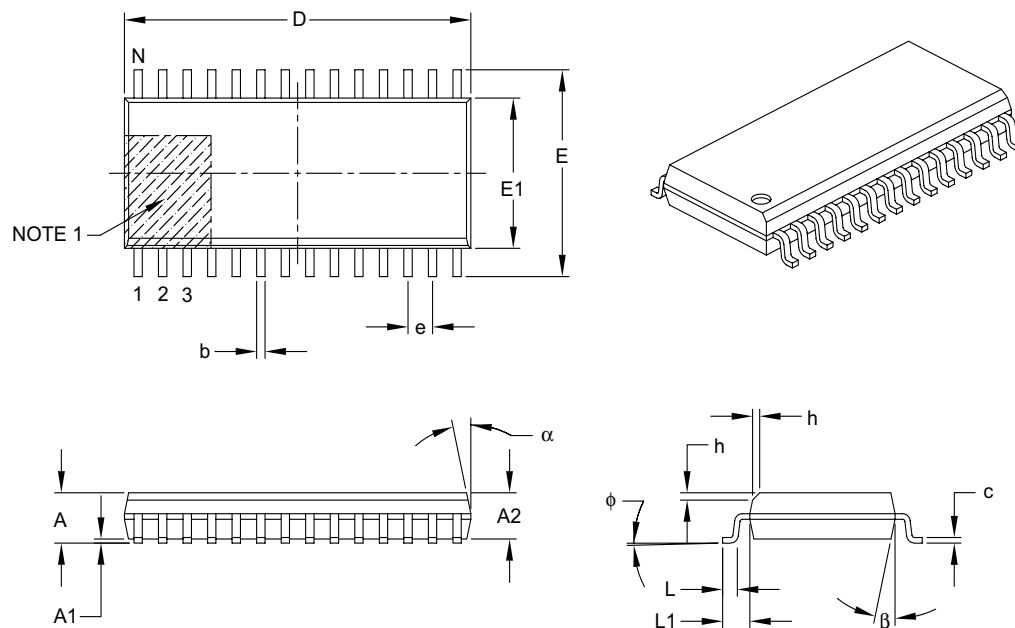
| Units                      |    | INCHES   |       |       |
|----------------------------|----|----------|-------|-------|
| Dimension Limits           |    | MIN      | NOM   | MAX   |
| Number of Pins             | N  | 28       |       |       |
| Pitch                      | e  | .100 BSC |       |       |
| Top to Seating Plane       | A  | –        | –     | .200  |
| Molded Package Thickness   | A2 | .120     | .135  | .150  |
| Base to Seating Plane      | A1 | .015     | –     | –     |
| Shoulder to Shoulder Width | E  | .290     | .310  | .335  |
| Molded Package Width       | E1 | .240     | .285  | .295  |
| Overall Length             | D  | 1.345    | 1.365 | 1.400 |
| Tip to Seating Plane       | L  | .110     | .130  | .150  |
| Lead Thickness             | c  | .008     | .010  | .015  |
| Upper Lead Width           | b1 | .040     | .050  | .070  |
| Lower Lead Width           | b  | .014     | .018  | .022  |
| Overall Row Spacing §      | eB | –        | –     | .430  |

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
- Dimensioning and tolerancing per ASME Y14.5M.

## 28-Lead Plastic Small Outline (SO) – Wide, 7.50 mm Body [SOIC]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



|                          |    | Units | MILLIMETERS |     |      |
|--------------------------|----|-------|-------------|-----|------|
| Dimension Limits         |    |       | MIN         | NOM | MAX  |
| Number of Pins           | N  |       | 28          |     |      |
| Pitch                    | e  |       | 1.27 BSC    |     |      |
| Overall Height           | A  |       | –           | –   | 2.65 |
| Molded Package Thickness | A2 |       | 2.05        | –   | –    |
| Standoff §               | A1 |       | 0.10        | –   | 0.30 |
| Overall Width            | E  |       | 10.30 BSC   |     |      |
| Molded Package Width     | E1 |       | 7.50 BSC    |     |      |
| Overall Length           | D  |       | 17.90 BSC   |     |      |
| Chamfer (optional)       | h  |       | 0.25        | –   | 0.75 |
| Foot Length              | L  |       | 0.40        | –   | 1.27 |
| Footprint                | L1 |       | 1.40 REF    |     |      |
| Foot Angle Top           | φ  |       | 0°          | –   | 8°   |
| Lead Thickness           | c  |       | 0.18        | –   | 0.33 |
| Lead Width               | b  |       | 0.31        | –   | 0.51 |
| Mold Draft Angle Top     | α  |       | 5°          | –   | 15°  |
| Mold Draft Angle Bottom  | β  |       | 5°          | –   | 15°  |

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- § Significant Characteristic.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

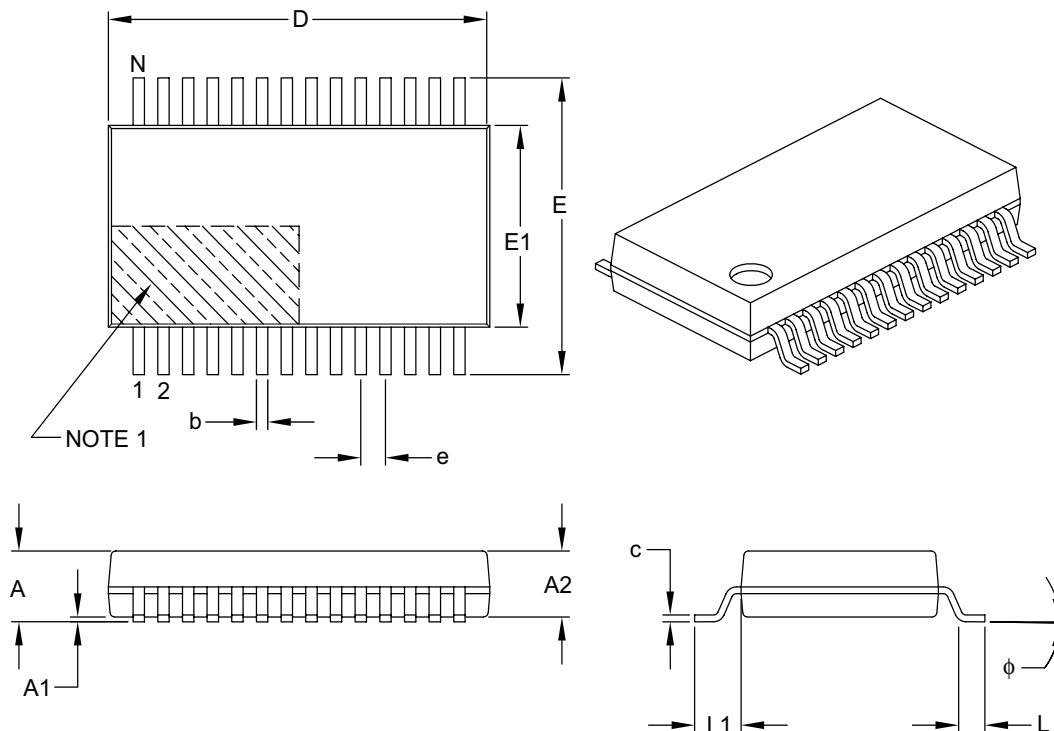
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-052B

# MCP23016

## 28-Lead Plastic Shrink Small Outline (SS) – 5.30 mm Body [SSOP]

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Dimension Limits         | Units | MILLIMETERS |       |       |
|--------------------------|-------|-------------|-------|-------|
|                          |       | MIN         | NOM   | MAX   |
| Number of Pins           | N     | 28          |       |       |
| Pitch                    | e     | 0.65 BSC    |       |       |
| Overall Height           | A     | –           | –     | 2.00  |
| Molded Package Thickness | A2    | 1.65        | 1.75  | 1.85  |
| Standoff                 | A1    | 0.05        | –     | –     |
| Overall Width            | E     | 7.40        | 7.80  | 8.20  |
| Molded Package Width     | E1    | 5.00        | 5.30  | 5.60  |
| Overall Length           | D     | 9.90        | 10.20 | 10.50 |
| Foot Length              | L     | 0.55        | 0.75  | 0.95  |
| Footprint                | L1    | 1.25 REF    |       |       |
| Lead Thickness           | c     | 0.09        | –     | 0.25  |
| Foot Angle               | φ     | 0°          | 4°    | 8°    |
| Lead Width               | b     | 0.22        | –     | 0.38  |

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.20 mm per side.
- Dimensioning and tolerancing per ASME Y14.5M.

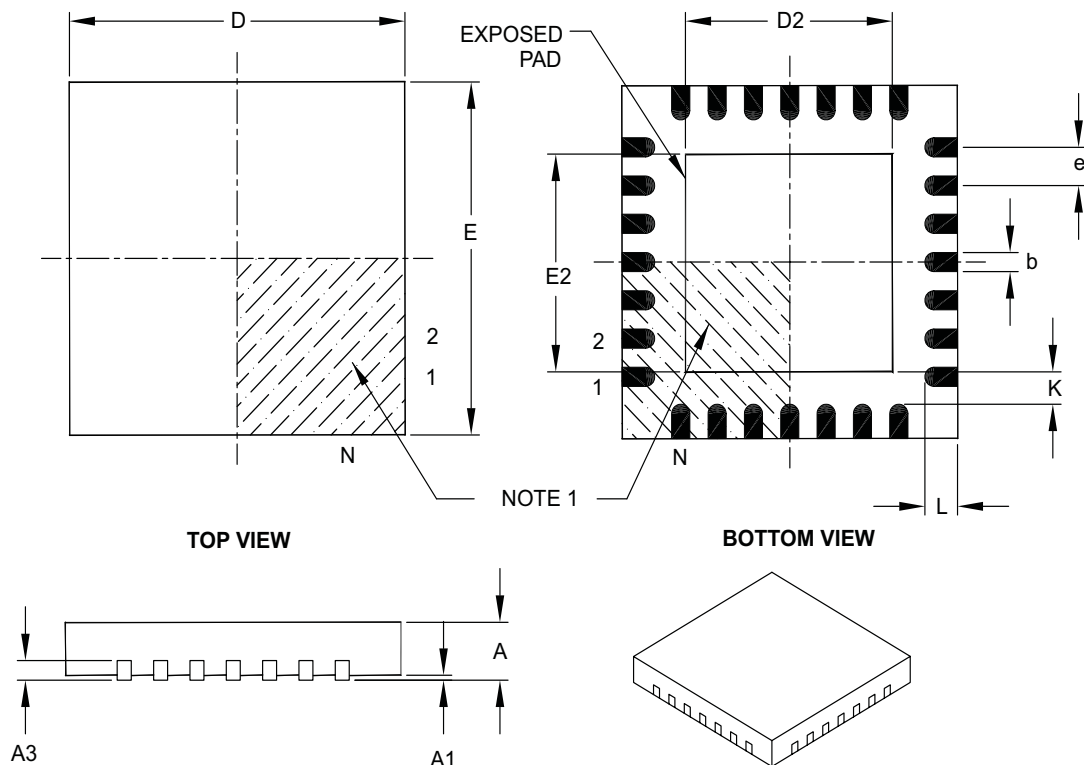
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-073B

## 28-Lead Plastic Quad Flat, No Lead Package (ML) – 6x6 mm Body [QFN] with 0.55 mm Contact Length

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



| Units                  |    | MILLIMETERS |      |      |
|------------------------|----|-------------|------|------|
| Dimension Limits       |    | MIN         | NOM  | MAX  |
| Number of Pins         | N  | 28          |      |      |
| Pitch                  | e  | 0.65 BSC    |      |      |
| Overall Height         | A  | 0.80        | 0.90 | 1.00 |
| Standoff               | A1 | 0.00        | 0.02 | 0.05 |
| Contact Thickness      | A3 | 0.20 REF    |      |      |
| Overall Width          | E  | 6.00 BSC    |      |      |
| Exposed Pad Width      | E2 | 3.65        | 3.70 | 4.20 |
| Overall Length         | D  | 6.00 BSC    |      |      |
| Exposed Pad Length     | D2 | 3.65        | 3.70 | 4.20 |
| Contact Width          | b  | 0.23        | 0.30 | 0.35 |
| Contact Length         | L  | 0.50        | 0.55 | 0.70 |
| Contact-to-Exposed Pad | K  | 0.20        | —    | —    |

### Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Package is saw singulated.
- Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-105B

# MCP23016

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NOTES:

## APPENDIX A: REVISION HISTORY

### Revision A (December 2002)

Original data sheet for MCP23016 device.

### Revision B (September 2003)

1. Addition of Output Low Voltage section to Table 2-1 in Electrical Characteristics.
2. Addition of Output High Voltage section to Table 2-1 in Electrical Characteristics.

### Revision C (January 2007)

This revision includes updates to the packaging diagrams.

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NOTES:

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information (e.g., on pricing or delivery) refer to the factory or the listed sales office.

| <u>PART NO.</u>    |                                                                                                                                                                                                 | <u>X</u>                                                                                                                                                                                                                                           | <u>/XX</u> |
|--------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------|
| Device             |                                                                                                                                                                                                 | Temperature Range                                                                                                                                                                                                                                  | Package    |
| Device:            | DSTEMP: 16-Bit I <sup>2</sup> C I/O Expander                                                                                                                                                    |                                                                                                                                                                                                                                                    |            |
| Temperature Range: | I = -40°C to +85°C                                                                                                                                                                              |                                                                                                                                                                                                                                                    |            |
| Package:           | SP = Plastic DIP (300 mil Body), 28-lead<br>SO = Plastic SOIC, Wide (300 mil Body), 28-lead<br>SS = Plastic SOIC, (209 mil, 5.30mm), 28-lead<br>ML = Plastic Quad, Flat No Leads (QFN), 28-lead |                                                                                                                                                                                                                                                    |            |
|                    |                                                                                                                                                                                                 | <b>Examples:</b><br>a) DSTEMP-I/P: Industrial Temperature, PDIP package.<br>a) DSTEMP-I/SO: Industrial Temperature, SOIC package.<br>a) DSTEMP-I/SS: Industrial Temperature, SOIC package.<br>a) DSTEMP-I/ML: Industrial Temperature, QFN package. |            |

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NOTES:

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